

● FEATURES

- 0.30 inch (7.62 mm) Digit Height.
- Low current operation.
- SMD type.
- Gray face, White segment.
- RoHS compliant, Pb Free.

● DESCRIPTION

The YSD-3010YG-GW & YSD-3011YG-GW are 0.30 inch (7.62mm) height Dual digit 7-segment display.

This device utilizes Super Bright Yellow Green LED chip which are made from AlGaInP on a transparent GaAs, substrate.

The display has Gray face, White segment.

● DEVICE

PART NO	DESCRIPTION
YSD-3010YG-GW	Common Anode
YSD-3011YG-GW	Common Cathode

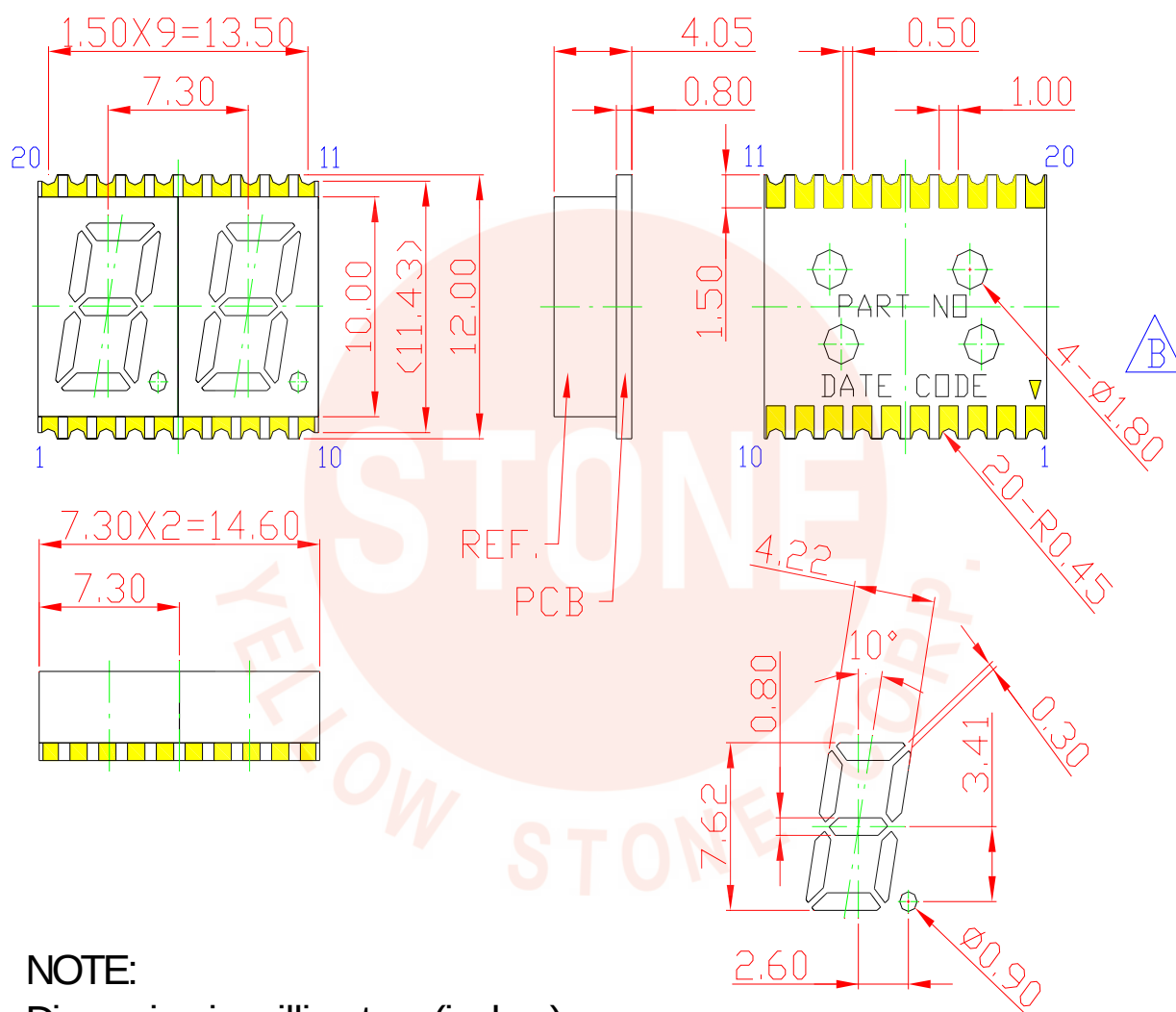
RoHS Compliance



Pb free.



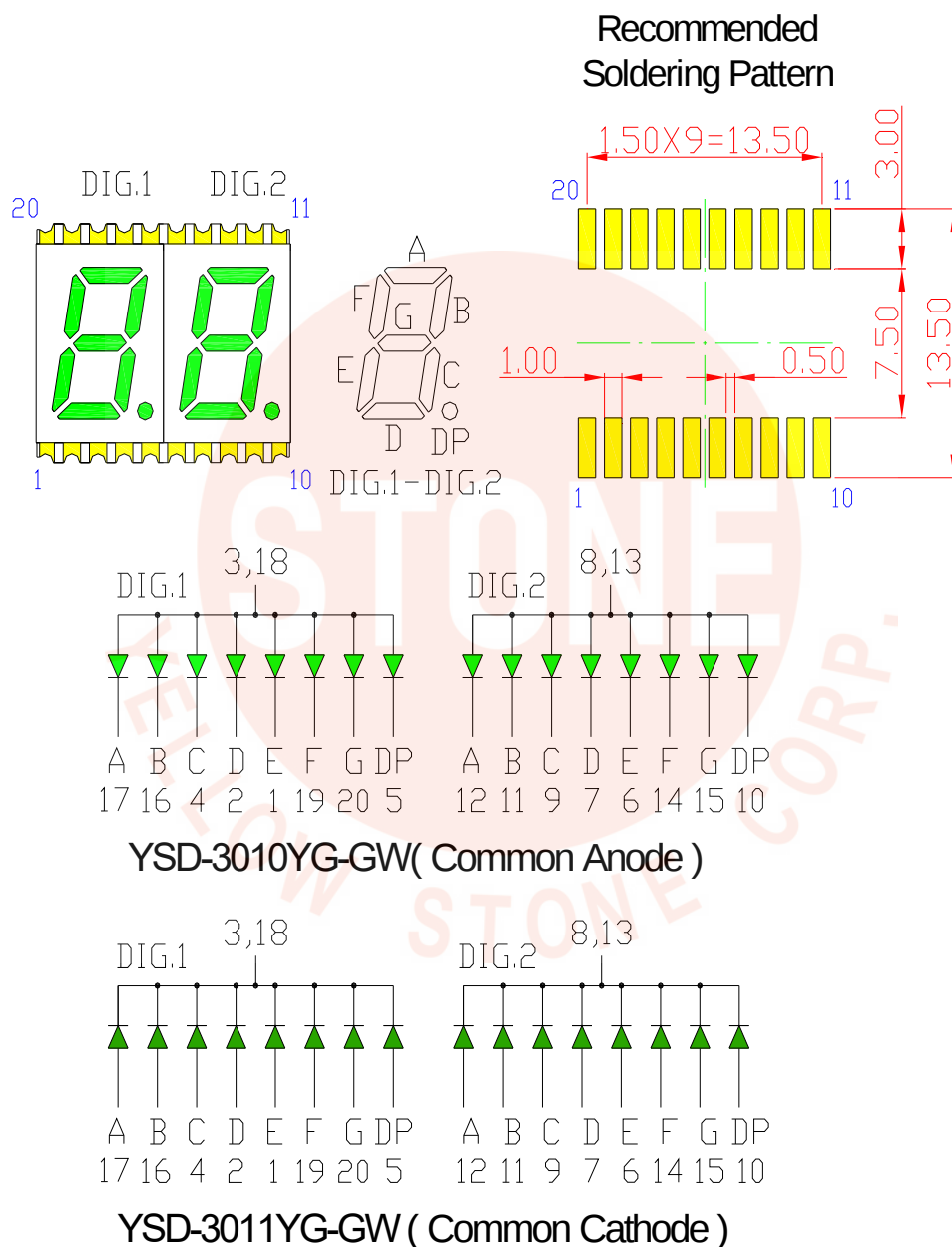
● MECHANICAL DIMENSIONS



NOTE:

Dimension in millimeters (inches),
 And tolerances are $\pm 0.25\text{mm}$ (.01") specified.

● TYPICAL INTERNAL EQUIVALENT CIRCUIT



● YG: SUPER BRIGHT YELLOW GREEN (AlGaInP/GaAs)

ABSOLUTE MAXIMUM RATING AT Ta=25°C

Parameter	Symbol	Maximum Rating	Unit
Power dissipation	P _{AD}	70	mW
Derating liner from 25°C	-	0.28	mA / °C
Continuous forward current	I _{AF}	25	mA
Peak current (duty cycle 1/10, 1kHz)	I _{PF}	90	mA
Reverse voltage	V _R	5	V
Operating temperature	T _{OPR}	-40 to +105	°C
Storage temperature	T _{STG}	-40 to +105	°C

ELECTRICAL - OPTICAL CHARACTERISTICS AT Ta=25°C

Characteristic	Symbol	Condition	Min.	Type.	Max.	Unit
Forward Voltage, (Per Dice)	V _F	I _F =20mA	-	2.1	2.5	V
Reverse Current, (Per Dice)	I _R	V _R =5V	-	-	10	μA
Peak Wavelength	λ _P	I _F =20mA	-	573	-	nm
Dominant Wavelength	λ _D	I _F =20mA	567	571	576	nm
Luminous Intensity	I _V	I _F =20mA	2	5	8	mcd
Spectral radiation bandwidth	Δλ	I _F =20mA	-	20	-	nm

● **YG: BIN GRADE (Unit : mcd) Test Condition: 5V / 20mA**

Super Bright Yellow Green	E	F	G
	2.0 – 4.0	4.1 – 6.0	6.1 – 8.0

● **YG: HUE GRADE (λ_D : nm)**

1	2	3
567~570	570.1~573	573.1~576

● **AVAILABLE BIN / HUE TABLE**

E1	F1	G1
E2	F2	G2
E3	F3	G3

● YG: SUPER BRIGHT YELLOW GREEN (AlGaInP/GaAs) CURVE

Typical Electro-optical Characteristic Curves (25°C Free Air Temperature Unless Otherwise Specified)

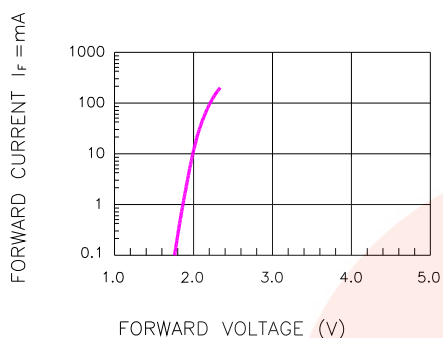


Fig.1 FORWARD CURRENT VS. FORWARD VOLTAGE

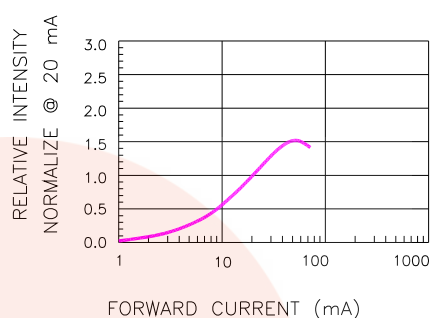


Fig.2 RELATIVE INTENSITY VS. FORWARD CURRENT

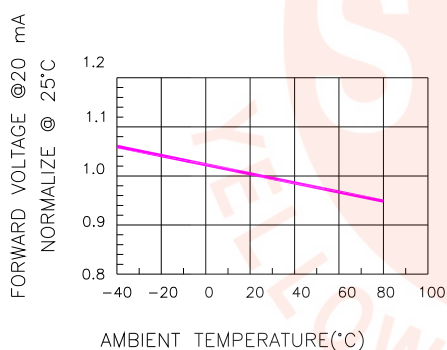


Fig.3 FORWARD VOLTAGE VS. TEMPERATURE

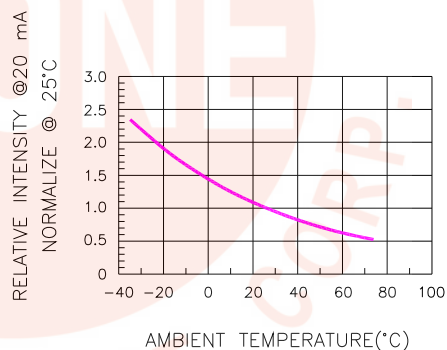


Fig.4 RELATIVE INTENSITY VS. TEMPERATURE

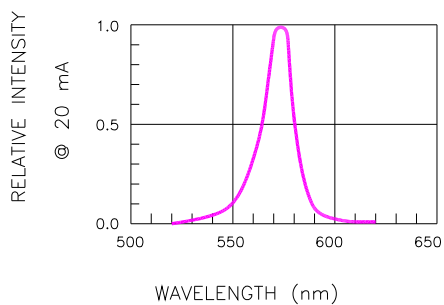


Fig.5 RELATIVE INTENSITY VS. WAVELENGTH

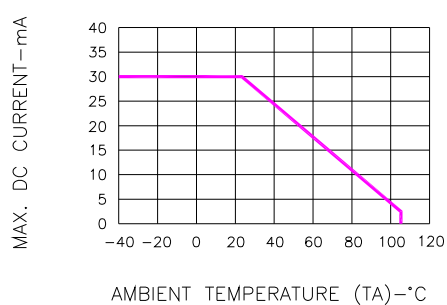
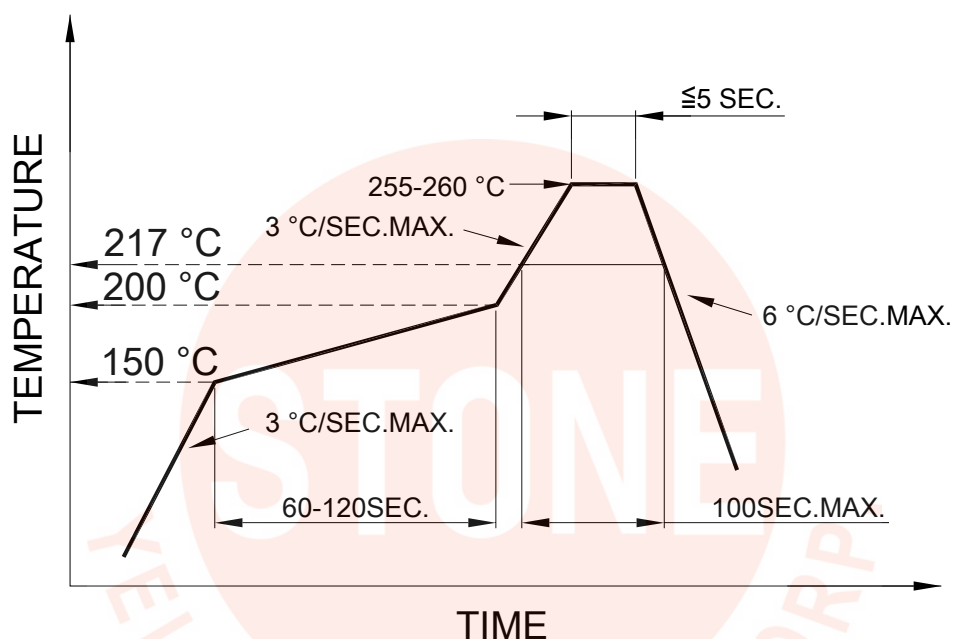


Fig.6 MAX. ALLOWABLE DC CURRENT VS. AMBIENT TEMPERATURE

● RECOMMEND SOLDERING PROFILE

SMT Soldering Profile

Pb free reflow soldering Profile



● SOLDERING IRON

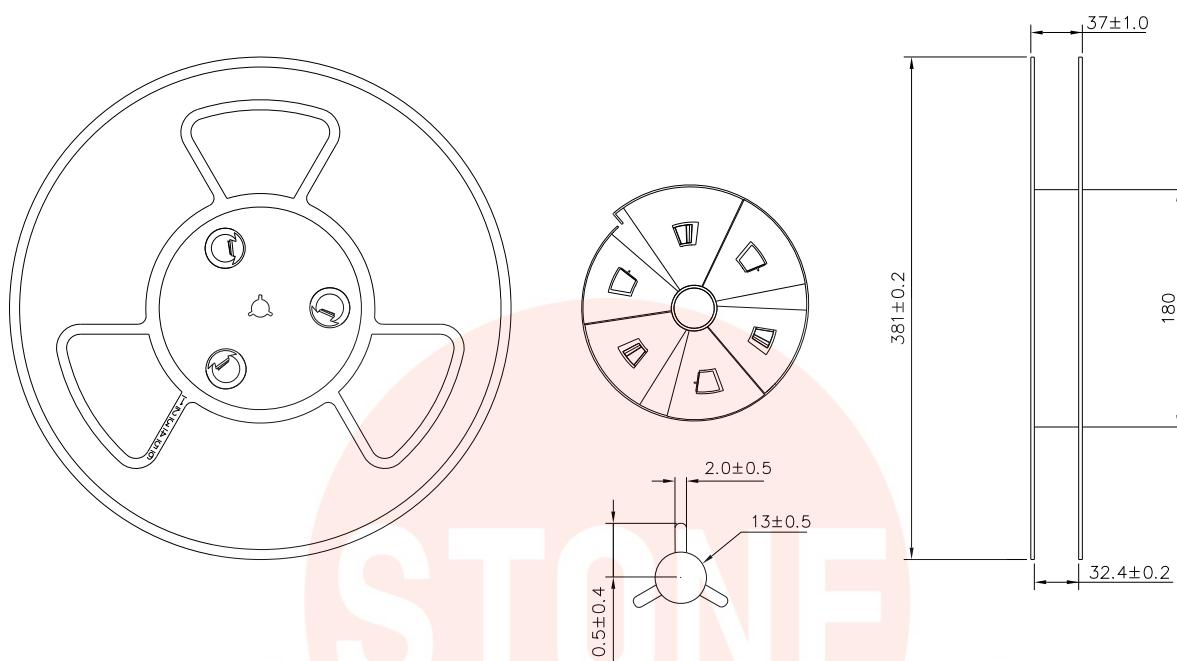
Basic specification : ≤ 4 seconds when 260°C, If temperature is higher, time should be shorter (+10°C→1 sec). Power dissipation of iron should be smaller than 15W, and temperature should be controllable. Surface temperature of the device should be under 230°C.

● REWORK

Customer must finish rework within 3 sec. under 350°C.

The head of soldering iron cannot touch copper foil.

● REEL DIMENSIONS



● PACKING & LABEL SPECIFICATIONS

